

#### 150V N-Channel MOSFET

#### **General Description**

The 12N15A uses advanced trench technology and design to provide excellent RDS(ON). This device is ideal for PWM, load switching and general purpose applications.

### **Features**

- Low On-Resistance
- High Reliability Capability with Passivation
- 100% avalanche tested
- RoHS Compliant

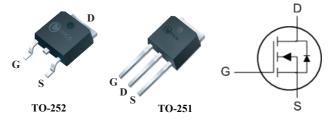
#### **Product Summary**

BVDSS	RDSON	ID
150V	0.36Ω	12A

## **Applications**

- DC-DC Converters
- Power switching application

## TO-252/251 Pin Configuration



Туре	Package	Marking
CMD12N15A	TO-252	CMD12N15A
CMU12N15A	TO-251	CMU12N15A

## **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units	
$V_{DS}$	Drain-Source Voltage	150	V	
V <sub>GS</sub>	Gate-Source Voltage	±20	V	
I <sub>D</sub> @T <sub>C</sub> =25℃	Continuous Drain Current	12	Α	
I <sub>D</sub> @T <sub>C</sub> =100℃	Continuous Drain Current	10	Α	
I <sub>DM</sub>	Pulsed Drain Current	36	Α	
EAS	Single Pulse Avalanche Energy	5.4	mJ	
P <sub>D</sub> @T <sub>C</sub> =25℃	Total Power Dissipation	50	W	
T <sub>STG</sub>	Storage Temperature Range -55 to 150		°C	
T <sub>J</sub>	Operating Junction Temperature Range -55 to 150		$^{\circ}$	

#### **Thermal Data**

Symbol	Parameter	Тур.	Max.	Unit
R <sub>eJA</sub>	Thermal Resistance Junction-ambien		44	°C/W
R <sub>θJC</sub>	Thermal Resistance Junction -Case		2.8	°C/W

# **CMD12N15A/CMU12N15A**



## 150V N-Channel MOSFET

# Electrical Characteristics (T\_J=25 $^{\circ}$ C , unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	150			V
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> =10V , I <sub>D</sub> =6A			0.36	Ω
		V <sub>GS</sub> =4.5V , I <sub>D</sub> =6A			0.42	
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS}=V_{DS}$ , $I_D=250uA$	1		3	V
	Drain-Source Leakage Current	V <sub>DS</sub> =150V, V <sub>GS</sub> =0V			1	- uA
I <sub>DSS</sub>		V <sub>DS</sub> =150V , V <sub>GS</sub> =0V , T <sub>J</sub> =125℃			5	
I <sub>GSS</sub>	Gate-Source Leakage Current	V <sub>GS</sub> = ±20V , V <sub>DS</sub> =0V			±100	nA
gfs	Forward Transconductance	$V_{DS}$ =10V , $I_{D}$ =6A		6		S
$R_g$	Gate Resistance	$V_{DS}$ =0V , $V_{GS}$ =0V , f=1MHz		2.5		Ω
$Q_g$	Total Gate Charge			12		
$Q_gs$	Gate-Source Charge	$V_{DS}$ =75V , $V_{GS}$ =10V , $I_{D}$ =7A		3		nC
$Q_gd$	Gate-Drain Charge			4		
$T_{d(on)}$	Turn-On Delay Time			6		
Tr	Rise Time	V <sub>DD</sub> =75V , V <sub>GS</sub> =10V		10		ns
$T_{d(off)}$	Turn-Off Delay Time	$R_G = 27\Omega$ , $I_{DS} = 7A$		16		
T <sub>f</sub>	Fall Time			21		
C <sub>iss</sub>	Input Capacitance			720		
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> =75V , V <sub>GS</sub> =0V , f=1MHz		25		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			13		

## **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			12	Α
V <sub>SD</sub>	Diode Forward Voltage	V <sub>GS</sub> =0V , I <sub>S</sub> =12A , T <sub>J</sub> =25℃			1.2	V

#### Note:

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